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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	19
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	24-LSSOP (0.220", 5.60mm Width)
Supplier Device Package	24-LSSOP
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f213g6ddsp-w4

1. Overview

1.1 Features

The R8C/3GD Group of single-chip MCUs incorporates the R8C CPU core, employing sophisticated instructions for a high level of efficiency. With 1 Mbyte of address space, and it is capable of executing instructions at high speed. In addition, the CPU core boasts a multiplier for high-speed operation processing.

Power consumption is low, and the supported operating modes allow additional power control. These MCUs are designed to maximize EMI/EMS performance.

Integration of many peripheral functions, including multifunction timer and serial interface, reduces the number of system components.

1.1.1 Applications

Electronic household appliances, office equipment, audio equipment, consumer equipment, etc.

1.1.2 Specifications

Tables 1.1 and 1.2 outline the Specifications for R8C/3GD Group.

Table 1.1 Specifications for R8C/3GD Group (1)

Item	Function	Specification
CPU	Central processing unit	R8C CPU core <ul style="list-style-type: none"> • Number of fundamental instructions: 89 • Minimum instruction execution time: 50 ns ($f(XIN) = 20$ MHz, VCC = 2.7 to 5.5 V) 200 ns ($f(XIN) = 5$ MHz, VCC = 1.8 to 5.5 V) • Multiplier: 16 bits \times 16 bits \rightarrow 32 bits • Multiply-accumulate instruction: 16 bits \times 16 bits + 32 bits \rightarrow 32 bits • Operation mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM	Refer to Table 1.3 Product List for R8C/3GD Group .
Power Supply Voltage Detection	Voltage detection circuit	<ul style="list-style-type: none"> • Power-on reset • Voltage detection 3 (detection level of voltage detection 0 and voltage detection 1 selectable)
I/O Ports	Programmable I/O ports	<ul style="list-style-type: none"> • Input-only: 1 pin • CMOS I/O ports: 19, selectable pull-up resistor • High current drive ports: 19
Clock	Clock generation circuits	4 circuits: XIN clock oscillation circuit, XCIN clock oscillation circuit (32 kHz) High-speed on-chip oscillator (with frequency adjustment function), Low-speed on-chip oscillator, <ul style="list-style-type: none"> • Oscillation stop detection: XIN clock oscillation stop detection function • Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16 • Low power consumption modes: Standard operating mode (high-speed clock, low-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode
		Real-time clock (timer RE)
Interrupts		<ul style="list-style-type: none"> • Number of interrupt vectors: 69 • External Interrupt: 7 (INT \times 3, Key input \times 4) • Priority levels: 7 levels
Watchdog Timer		<ul style="list-style-type: none"> • 14 bits \times 1 (with prescaler) • Reset start selectable • Low-speed on-chip oscillator for watchdog timer selectable
Timer	Timer RA	8 bits \times 1 (with 8-bit prescaler) Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
	Timer RB	8 bits \times 1 (with 8-bit prescaler) Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode
	Timer RC	16 bits \times 1 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output 3 pins), PWM2 mode (PWM output pin)
	Timer RE	8 bits \times 1 Real-time clock mode (count seconds, minutes, hours, days of week)
Serial Interface	UART0	Clock synchronous serial I/O/UART
	UART2	Clock synchronous serial I/O/UART, I ² C mode (I ² C-bus), multiprocessor communication function
A/D Converter		10-bit resolution \times 8 channels, includes sample and hold function, with sweep mode
Comparator B		2 circuits

1.3 Block Diagram

Figure 1.2 shows a Block Diagram.

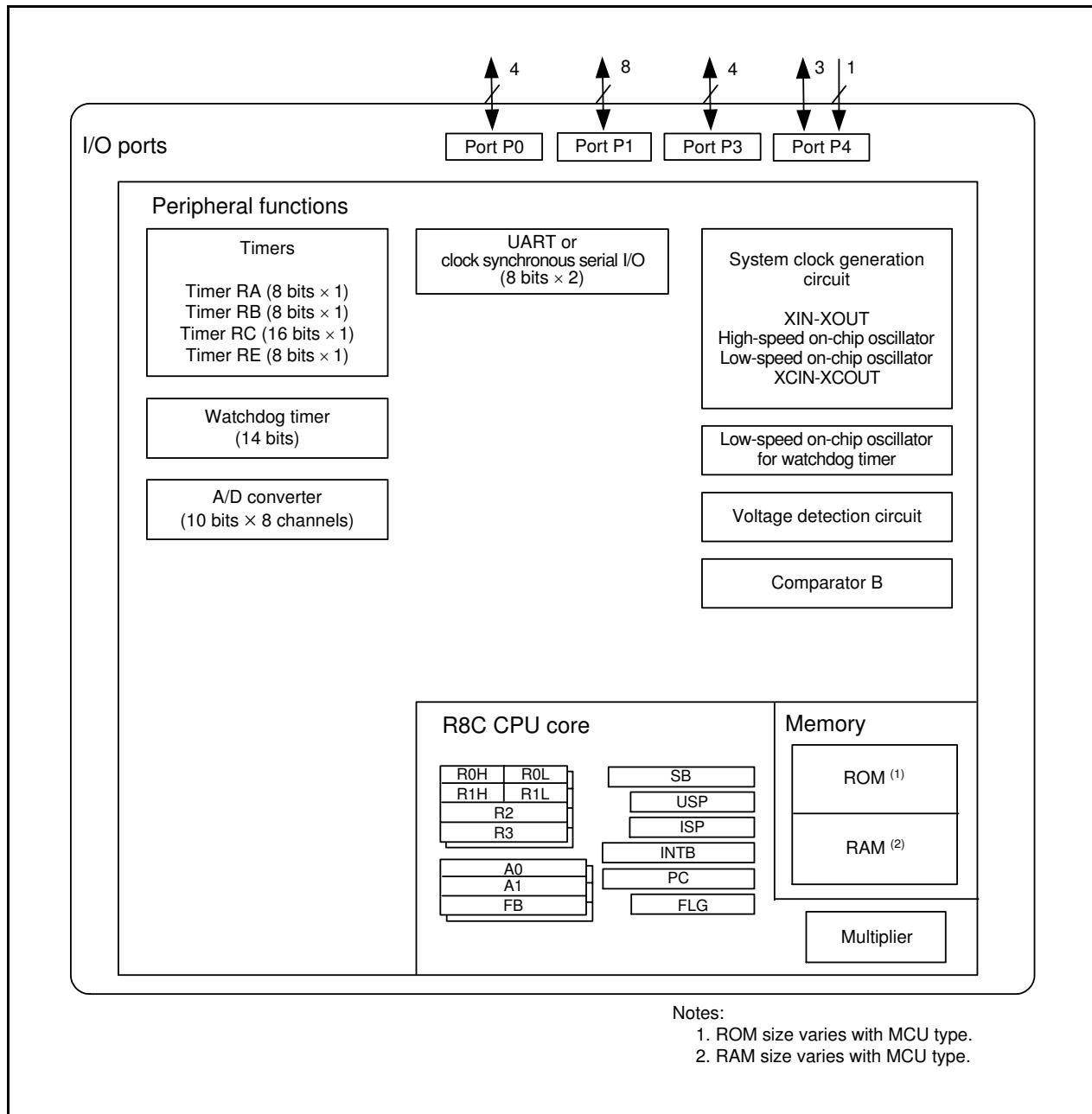


Figure 1.2 Block Diagram

1.5 Pin Functions

Table 1.5 lists Pin Functions.

Table 1.5 Pin Functions

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	—	Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	RESET	I	Input “L” on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins ⁽¹⁾ . To use an external clock, input it to the XOUT pin and leave the XIN pin open.
XIN clock output	XOUT	I/O	
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins ⁽¹⁾ . To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
XCIN clock output	XCOUT	O	
INT interrupt input	INT0, INT1, INT3	I	INT interrupt input pins. INT0 is timer RB, and RC input pin.
Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
Timer RA	TRAIO	I/O	Timer RA I/O pin
	TRAO	O	Timer RA output pin
Timer RB	TRBO	O	Timer RB output pin
Timer RC	TRCCLK	I	External clock input pin
	TRCTRG	I	External trigger input pin
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Timer RC I/O pins
Serial interface	CLK0, CLK2	I/O	Transfer clock I/O pins
	RXD0, RXD2	I	Serial data input pins
	TXD0, TXD2	O	Serial data output pins
	CTS2	I	Transmission control input pin
	RTS2	O	Reception control output pin
	SCL2	I/O	I ² C mode clock I/O pin
	SDA2	I/O	I ² C mode data I/O pin
Reference voltage input	VREF	I	Reference voltage input pin to A/D converter
A/D converter	AN0, AN1, AN5, AN6, AN8 to AN11	I	Analog input pins to A/D converter
	ADTRG	I	A/D external trigger input pin
Comparator B	IVCMP1, IVCMP3	I	Comparator B analog voltage input pins
	IVREF1, IVREF3	I	Comparator B reference voltage input pins
I/O port	P0_1, P0_2, P0_6, P0_7, P1_0 to P1_7, P3_3 to P3_5, P3_7, P4_5 to P4_7	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. All ports can be used as LED drive ports.
Input port	P4_2	I	Input-only port

I: Input O: Output I/O: Input and output

Note:

1. Refer to the oscillator manufacturer for oscillation characteristics.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

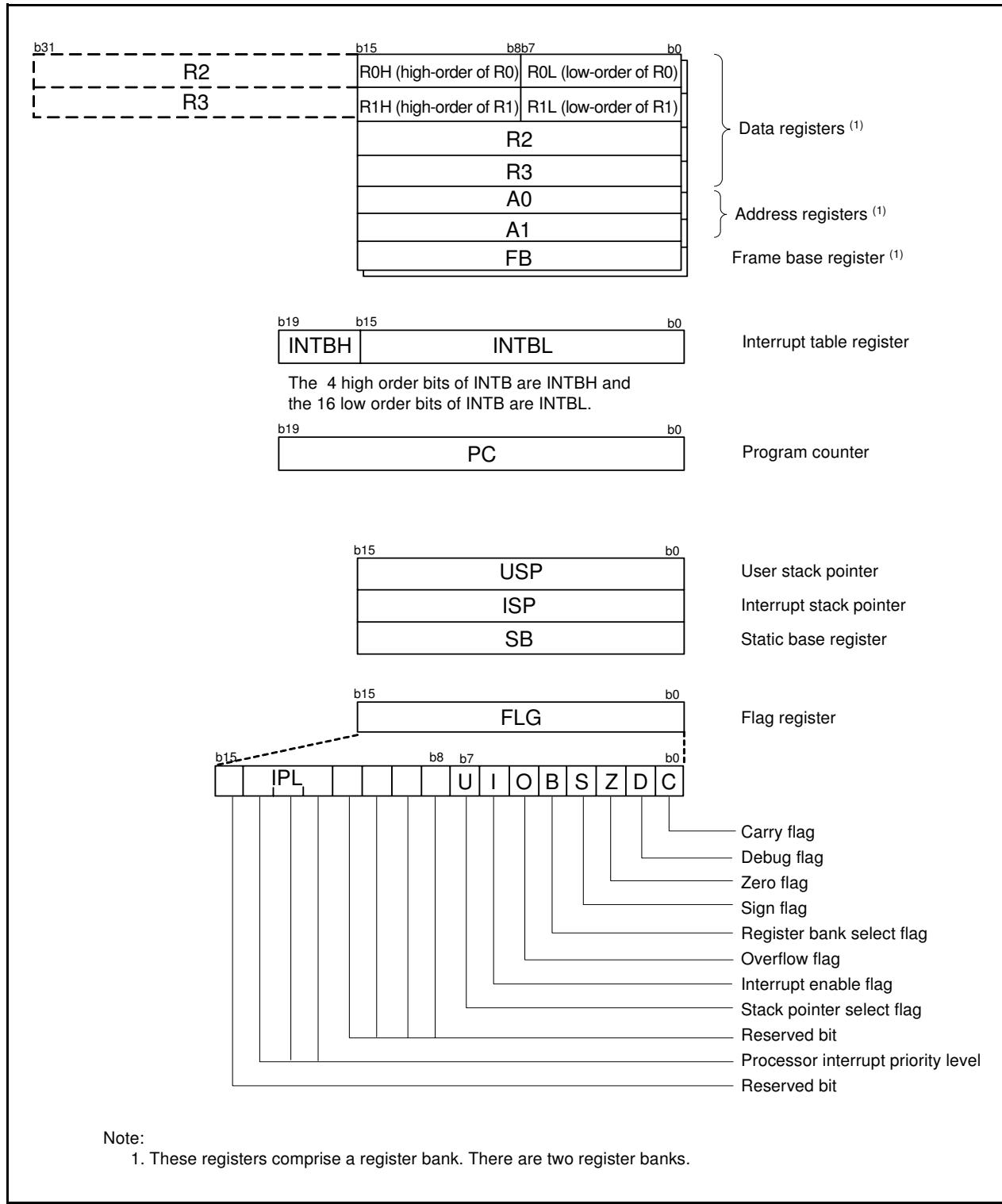


Figure 2.1 CPU Registers

2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.

3. Memory

3.1 R8C/3GD Group

Figure 3.1 is a Memory Map of R8C/3GD Group. The R8C/3GD Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM area is allocated addresses 0C000h to 0FFFFh. The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 1-Kbyte internal RAM area is allocated addresses 00400h to 007FFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.

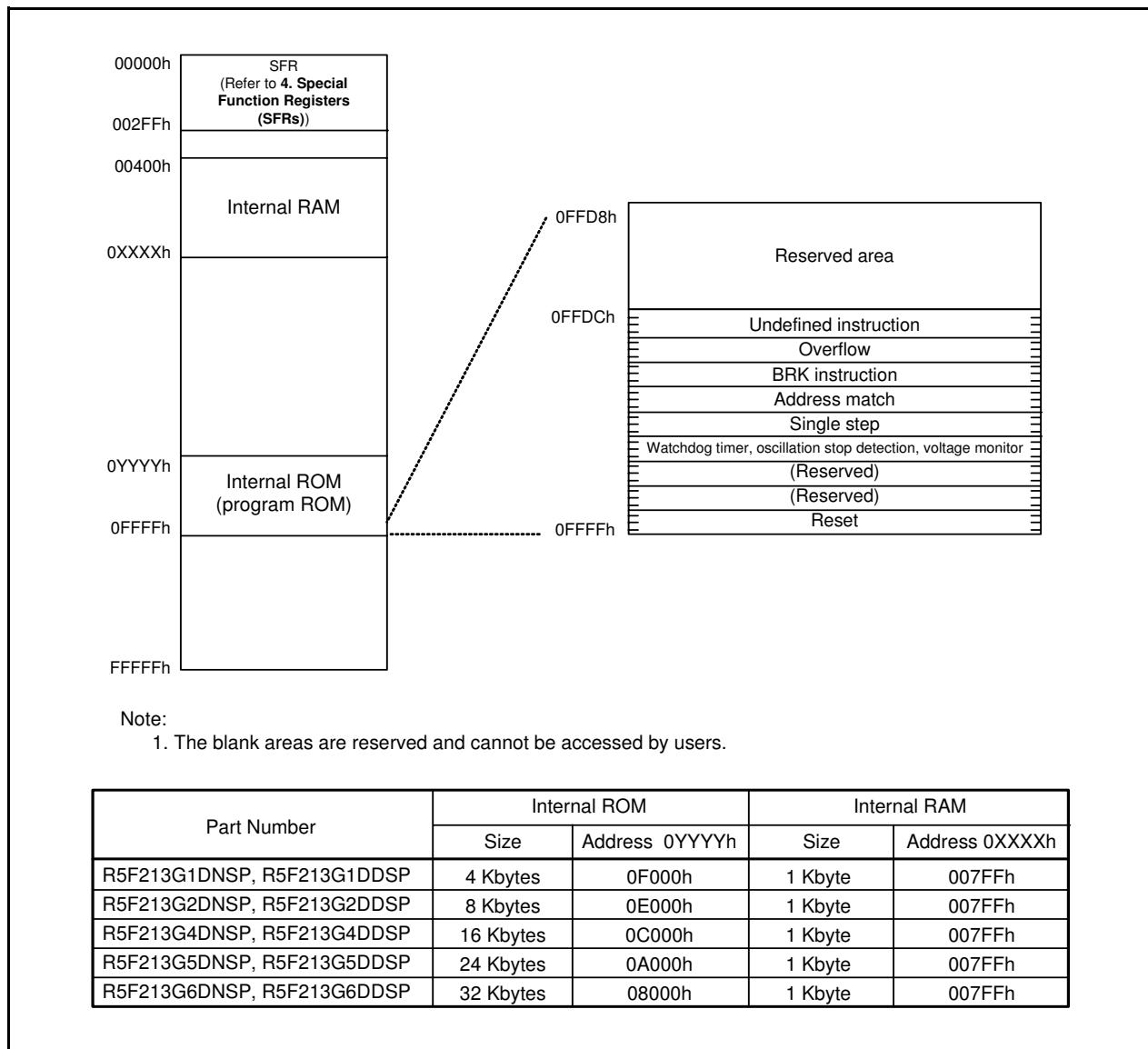


Figure 3.1 Memory Map of R8C/3GD Group

4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.7 list the special function registers and Table 4.8 lists the ID Code Areas and Option Function Select Area.

Table 4.1 SFR Information (1) (1)

Address	Register	Symbol	After Reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	00101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h	Module Standby Control Register	MSTCR	00h
0009h	System Clock Control Register 3	CM3	00h
000Ah	Protect Register	PRCR	00h
000Bh	Reset Source Determination Register	RSTFR	0XXXXXXXb (2)
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDTC	00111111b
0010h			
0011h			
0012h			
0013h			
0014h			
0015h	High-Speed On-Chip Oscillator Control Register 7	FRA7	When shipping
0016h			
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h 10000000b (3)
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h	On-Chip Reference Voltage Control Register	OCVREFCR	00h
0027h			
0028h	Clock Prescaler Reset Flag	CPSRF	00h
0029h	High-Speed On-Chip Oscillator Control Register 4	FRA4	When Shipping
002Ah	High-Speed On-Chip Oscillator Control Register 5	FRA5	When Shipping
002Bh	High-Speed On-Chip Oscillator Control Register 6	FRA6	When Shipping
002Ch			
002Dh			
002Eh			
002Fh	High-Speed On-Chip Oscillator Control Register 3	FRA3	When shipping
0030h	Voltage Monitor Circuit Control Register	CMPA	00h
0031h	Voltage Monitor Circuit Edge Select Register	VCAC	00h
0032h			
0033h	Voltage Detect Register 1	VCA1	00001000b
0034h	Voltage Detect Register 2	VCA2	00h (4) 00100000b (5)
0035h			
0036h	Voltage Detection 1 Level Select Register	VD1LS	00000111b
0037h			
0038h	Voltage Monitor 0 Circuit Control Register	VW0C	1100X010b (4) 1100X011b (5)
0039h	Voltage Monitor 1 Circuit Control Register	VW1C	10001010b

X: Undefined

Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. The CWR bit in the RSTFR register is set to 0 after power-on and voltage monitor 0 reset. Hardware reset, software reset, or watchdog timer reset does not affect this bit.
3. The CSPROINI bit in the OFS register is set to 0.
4. The LVDAS bit in the OFS register is set to 1.
5. The LVDAS bit in the OFS register is set to 0.

Table 4.2 SFR Information (2) (1)

Address	Register	Symbol	After Reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0042h			
0043h			
0044h			
0045h			
0046h			
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h			
0049h			
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
004Ch	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh			
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h			
0054h			
0055h			
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch			
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh	UART2 Bus Collision Detection Interrupt Control Register	U2BCNIC	XXXXX000b
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h	Voltage Monitor 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	Voltage Monitor 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.3 SFR Information (3) (1)

Address	Register	Symbol	After Reset
0080h			
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			
0094h			
0095h			
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit / Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh XXh
00A3h			
00A4h	UART0 Transmit / Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit / Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh XXh
00A7h			
00A8h	UART2 Transmit / Receive Mode Register	U2MR	00h
00A9h	UART2 Bit Rate Register	U2BRG	XXh
00AAh	UART2 Transmit Buffer Register	U2TB	XXh XXh
00ABh			
00ACh	UART2 Transmit / Receive Control Register 0	U2C0	00001000b
00ADh	UART2 Transmit / Receive Control Register 1	U2C1	00000010b
00AEh	UART2 Receive Buffer Register	U2RB	XXh XXh
00AFh			
00B0h	UART2 Digital Filter Function Select Register	URXDF	00h
00B1h			
00B2h			
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			
00B8h			
00B9h			
00BAh			
00BBh	UART2 Special Mode Register 5	U2SMR5	00h
00BCh	UART2 Special Mode Register 4	U2SMR4	00h
00BDh	UART2 Special Mode Register 3	U2SMR3	000X0X0Xb
00BEh	UART2 Special Mode Register 2	U2SMR2	X0000000b
00BFh	UART2 Special Mode Register	U2SMR	X0000000b

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.5 SFR Information (5) (1)

Address	Register	Symbol	After Reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h			
0106h			
0107h			
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h			
0115h			
0116h			
0117h			
0118h	Timer RE Second Data Register	TRESEC	00h
0119h	Timer RE Minute Data Register	TREMIN	00h
011Ah	Timer RE Hour Data Register	TREHR	00h
011Bh	Timer RE Day of Week Data Register	TREWK	00h
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h 00h
0127h			
0128h	Timer RC General Register A	TRCGRA	FFh FFh
0129h			
012Ah	Timer RC General Register B	TRCGRB	FFh FFh
012Bh			
012Ch	Timer RC General Register C	TRGRC	FFh FFh
012Dh			
012Eh	Timer RC General Register D	TRGRD	FFh FFh
012Fh			
0130h	Timer RC Control Register 2	TRCCR2	00011000b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	Timer RC Trigger Control Register	TRCADCR	00h
0134h			
0135h			
0136h			
0137h			
0138h			
0139h			
013Ah			
013Bh			
013Ch			
013Dh			
013Eh			
013Fh			
0140h			
:			
017Fh			

Note:

- The blank areas are reserved and cannot be accessed by users.

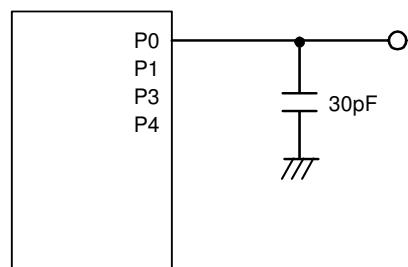


Figure 5.1 Ports P0, P1, P3, P4 Timing Measurement Circuit

Timing Requirements (Unless Otherwise Specified: V_{CC} = 5 V, V_{SS} = 0 V at T_{OPR} = 25°C)

Table 5.15 External clock input (XOUT, XCIN)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _C (XOUT)	XOUT input cycle time	50	—	ns
t _{WH} (XOUT)	XOUT input "H" width	24	—	ns
t _{WL} (XOUT)	XOUT input "L" width	24	—	ns
t _C (XCIN)	XCIN input cycle time	14	—	μs
t _{WH} (XCIN)	XCIN input "H" width	7	—	μs
t _{WL} (XCIN)	XCIN input "L" width	7	—	μs

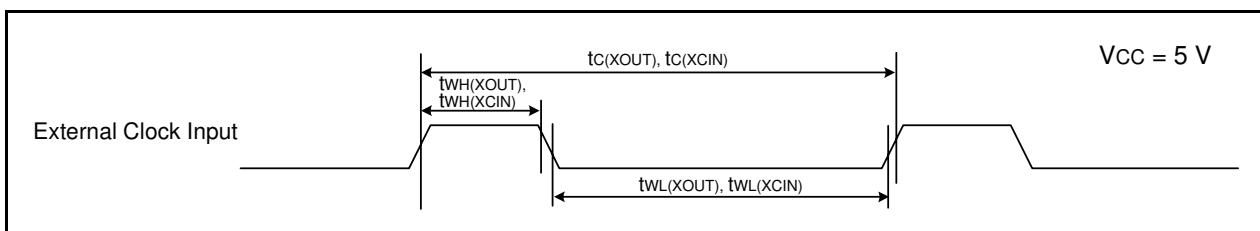


Figure 5.4 External Clock Input Timing Diagram when V_{CC} = 5 V

Table 5.16 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _C (TRAIO)	TRAIO input cycle time	100	—	ns
t _{WH} (TRAIO)	TRAIO input "H" width	40	—	ns
t _{WL} (TRAIO)	TRAIO input "L" width	40	—	ns

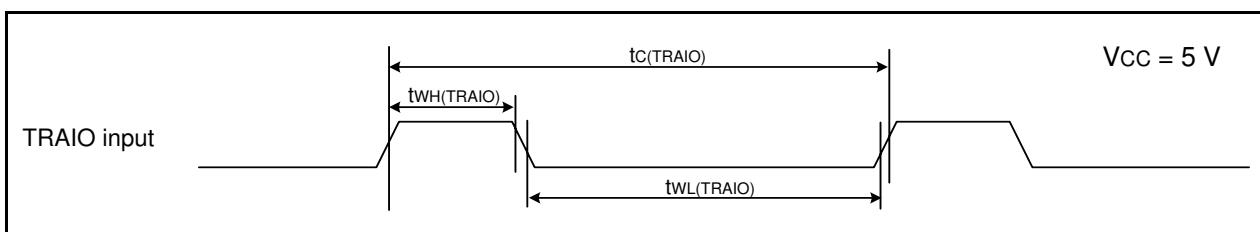


Figure 5.5 TRAIO Input Timing Diagram when V_{CC} = 5 V

Table 5.19 Electrical Characteristics (3) [2.7 V ≤ Vcc < 4.2 V]

Symbol	Parameter	Condition	Standard			Unit		
			Min.	Typ.	Max.			
VOH	Output "H" voltage	Other than XOUT	Drive capacity High	IOH = -5 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity Low	IOH = -1 mA	Vcc - 0.5	-	Vcc	V
		XOUT		IOH = -200 μA	1.0	-	Vcc	V
VOL	Output "L" voltage	Other than XOUT	Drive capacity High	IOL = 5 mA	-	-	0.5	V
			Drive capacity Low	IOL = 1 mA	-	-	0.5	V
		XOUT		IOL = 200 μA	-	-	0.5	V
VT+VT-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, ADTRG, RXD0, RXD2, CLK0, CLK2	Vcc = 3.0 V		0.1	0.4	-	V
		RESET	Vcc = 3.0 V		0.1	0.5	-	V
I _{IH}	Input "H" current		VI = 3 V, Vcc = 3.0 V		-	-	4.0	μA
I _{IL}	Input "L" current		VI = 0 V, Vcc = 3.0 V		-	-	-4.0	μA
R _{PULLUP}	Pull-up resistance		VI = 0 V, Vcc = 3.0 V		42	84	168	kΩ
R _{IXIN}	Feedback resistance	XIN			-	0.3	-	MΩ
R _{IXCIN}	Feedback resistance	XCIN			-	8	-	MΩ
V _{RAM}	RAM hold voltage		During stop mode		1.8	-	-	V

Note:

- 2.7 V ≤ Vcc < 4.2 V at $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), $f(XIN) = 10$ MHz, unless otherwise specified.

Timing Requirements (Unless Otherwise Specified: V_{CC} = 3 V, V_{SS} = 0 V at T_{OPR} = 25°C)

Table 5.21 External clock input (XOUT, XCIN)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _c (XOUT)	XOUT input cycle time	50	—	ns
t _{WH} (XOUT)	XOUT input "H" width	24	—	ns
t _{WL} (XOUT)	XOUT input "L" width	24	—	ns
t _c (XCIN)	XCIN input cycle time	14	—	μs
t _{WH} (XCIN)	XCIN input "H" width	7	—	μs
t _{WL} (XCIN)	XCIN input "L" width	7	—	μs

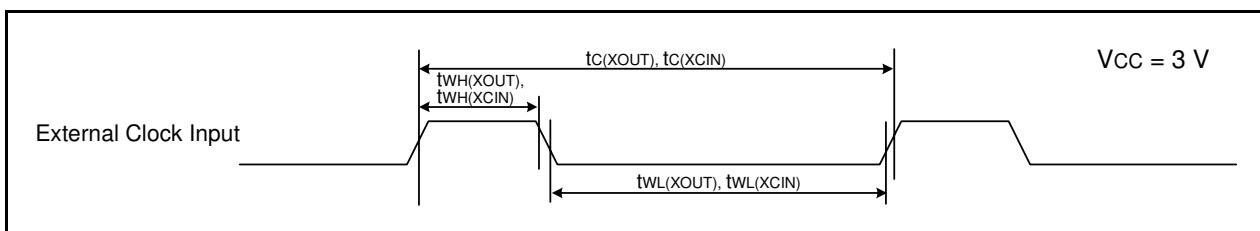


Figure 5.8 External Clock Input Timing Diagram when V_{CC} = 3 V

Table 5.22 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _c (TRAIO)	TRAIO input cycle time	300	—	ns
t _{WH} (TRAIO)	TRAIO input "H" width	120	—	ns
t _{WL} (TRAIO)	TRAIO input "L" width	120	—	ns

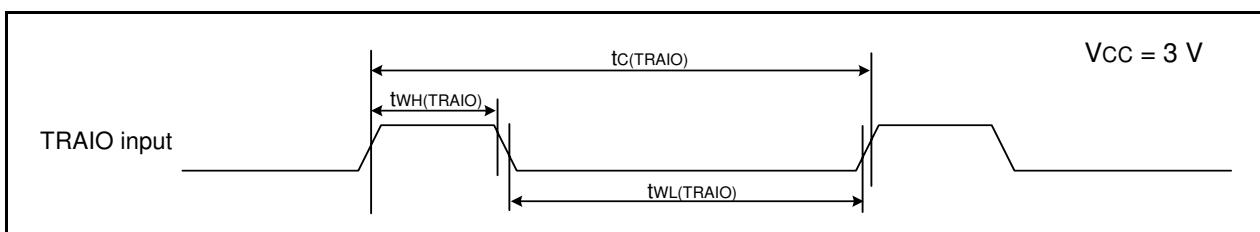
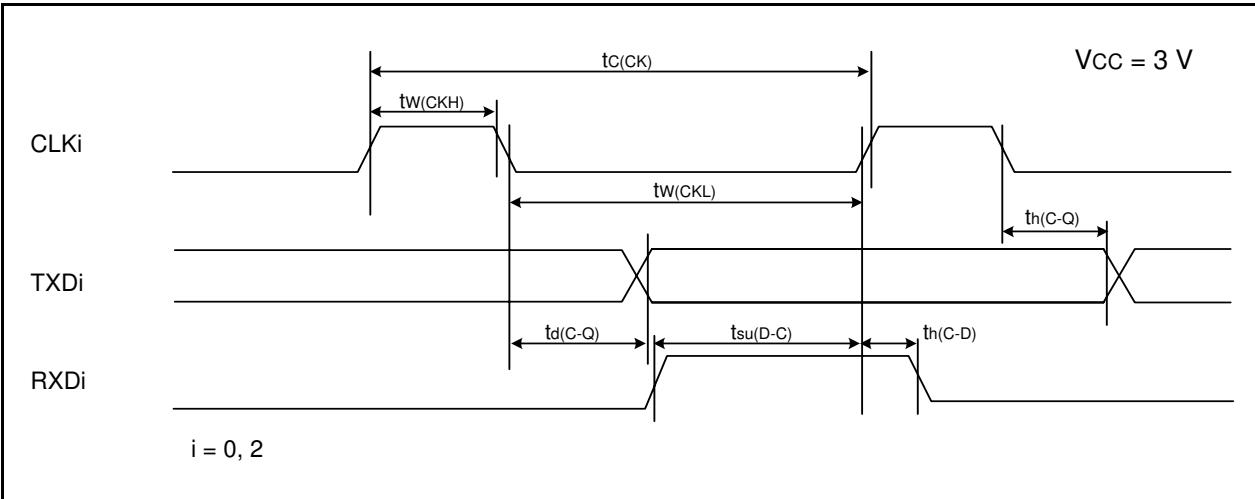


Figure 5.9 TRAIO Input Timing Diagram when V_{CC} = 3 V

Table 5.23 Serial Interface

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLK <i>i</i> input cycle time	300	—	ns
$t_{w(CKH)}$	CLK <i>i</i> input "H" width	150	—	ns
$t_{w(CKL)}$	CLK <i>i</i> Input "L" width	150	—	ns
$t_{d(C-Q)}$	TXD <i>i</i> output delay time	—	80	ns
$t_{h(C-Q)}$	TXD <i>i</i> hold time	0	—	ns
$t_{su(D-C)}$	RXD <i>i</i> input setup time	70	—	ns
$t_{h(C-D)}$	RXD <i>i</i> input hold time	90	—	ns

 $i = 0, 2$ **Figure 5.10 Serial Interface Timing Diagram when $V_{CC} = 3 \text{ V}$** **Table 5.24 External Interrupt $\overline{\text{INT}}_i$ ($i = 0, 1, 3$) Input, Key Input Interrupt $\overline{\text{K}}_i$ ($i = 0$ to 3)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(\text{INH})}$	$\overline{\text{INT}}_i$ input "H" width, $\overline{\text{K}}_i$ input "H" width	380 (1)	—	ns
$t_{w(\text{INL})}$	$\overline{\text{INT}}_i$ input "L" width, $\overline{\text{K}}_i$ input "L" width	380 (2)	—	ns

Notes:

- When selecting the digital filter by the $\overline{\text{INT}}_i$ input filter select bit, use an $\overline{\text{INT}}_i$ input HIGH width of either (1/digital filter clock frequency \times 3) or the minimum value of standard, whichever is greater.
- When selecting the digital filter by the $\overline{\text{INT}}_i$ input filter select bit, use an $\overline{\text{INT}}_i$ input LOW width of either (1/digital filter clock frequency \times 3) or the minimum value of standard, whichever is greater.

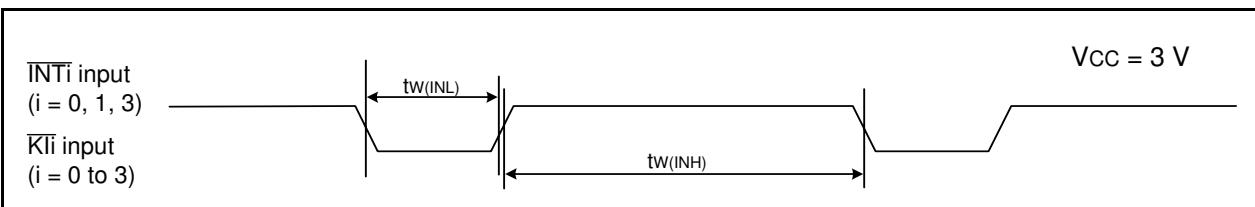
**Figure 5.11 Input Timing for External Interrupt $\overline{\text{INT}}_i$ and Key Input Interrupt $\overline{\text{K}}_i$ when $V_{CC} = 3 \text{ V}$**

Table 5.25 Electrical Characteristics (5) [1.8 V ≤ Vcc < 2.7 V]

Symbol	Parameter	Condition	Standard			Unit		
			Min.	Typ.	Max.			
VOH	Output "H" voltage	Other than XOUT	Drive capacity High	I _{OH} = -2 mA	V _{CC} - 0.5	-	V _{CC}	
			Drive capacity Low	I _{OH} = -1 mA	V _{CC} - 0.5	-	V _{CC}	
		XOUT		I _{OH} = -200 μA	1.0	-	V _{CC}	
VOL	Output "L" voltage	Other than XOUT	Drive capacity High	I _{OL} = 2 mA	-	-	0.5	
			Drive capacity Low	I _{OL} = 1 mA	-	-	0.5	
		XOUT		I _{OL} = 200 μA	-	-	0.5	
VT+VT-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, ADTRG, RXD0, RXD2, CLK0, CLK2			0.05	0.2	-	V
		RESET			0.05	0.20	-	V
I _{IH}	Input "H" current		VI = 2.2 V, V _{CC} = 2.2 V	-	-	4.0	μA	
I _{IL}	Input "L" current		VI = 0 V, V _{CC} = 2.2 V	-	-	-4.0	μA	
R _{PULLUP}	Pull-up resistance		VI = 0 V, V _{CC} = 2.2 V	70	140	300	kΩ	
R _{IXIN}	Feedback resistance	XIN		-	0.3	-	MΩ	
R _{IXCIN}	Feedback resistance	XCIN		-	8	-	MΩ	
V _{RAM}	RAM hold voltage		During stop mode	1.8	-	-	V	

Note:

1. 1.8 V ≤ V_{CC} < 2.7 V at T_{OPR} = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 5 MHz, unless otherwise specified.

**Table 5.26 Electrical Characteristics (6) [1.8 V ≤ Vcc < 2.7 V]
(Topr = –20 to 85°C (N version) / –40 to 85°C (D version), unless otherwise specified.)**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
Icc	Power supply current (Vcc = 1.8 to 2.7 V) Single-chip mode, output pins are open, other pins are Vss	High-speed clock mode	XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	—	2.2	— mA
			XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	—	0.8	— mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 5 MHz Low-speed on-chip oscillator on = 125 kHz No division	—	2.5	10 mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 5 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	—	1.7	— mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16 MSTTRC = 1	—	1	— mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	—	90	300 μA
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division FMR27 = 1, VCA20 = 0	—	80	350 μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division Program operation on RAM Flash memory off, FMSTP = 1, VCA20 = 0	—	40	— μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	—	15	90 μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	—	4	80 μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (peripheral clock off) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	—	3.5	— μA
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	—	2.0	5 μA
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	—	5.0	— μA

Timing Requirements (Unless Otherwise Specified: V_{CC} = 2.2 V, V_{SS} = 0 V at T_{OPR} = 25°C)

Table 5.27 External clock input (XOUT, XCIN)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _c (XOUT)	XOUT input cycle time	200	—	ns
t _{WH} (XOUT)	XOUT input "H" width	90	—	ns
t _{WL} (XOUT)	XOUT input "L" width	90	—	ns
t _c (XCIN)	XCIN input cycle time	14	—	μs
t _{WH} (XCIN)	XCIN input "H" width	7	—	μs
t _{WL} (XCIN)	XCIN input "L" width	7	—	μs

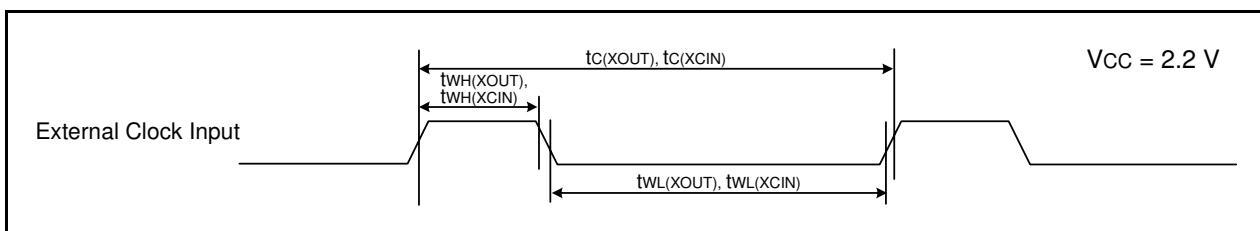


Figure 5.12 External Clock Input Timing Diagram when V_{CC} = 2.2 V

Table 5.28 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _c (TRAIO)	TRAIO input cycle time	500	—	ns
t _{WH} (TRAIO)	TRAIO input "H" width	200	—	ns
t _{WL} (TRAIO)	TRAIO input "L" width	200	—	ns

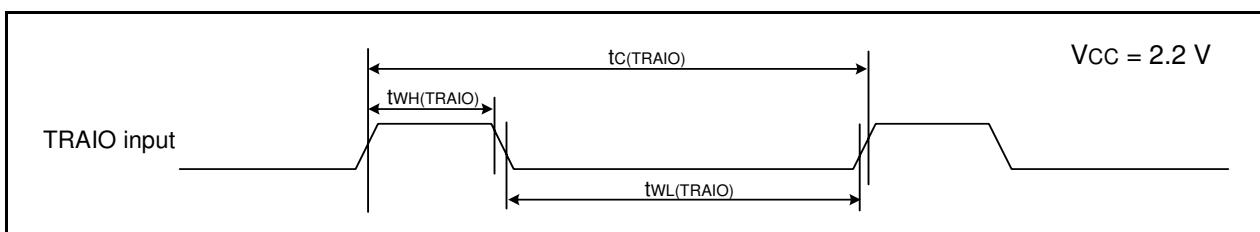
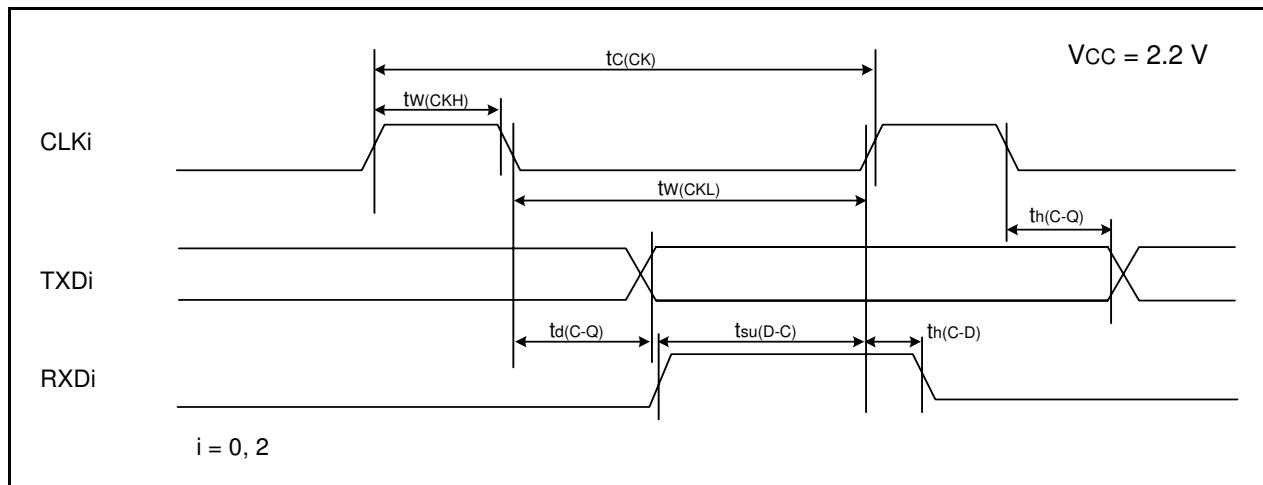


Figure 5.13 TRAIO Input Timing Diagram when V_{CC} = 2.2 V

Table 5.29 Serial Interface

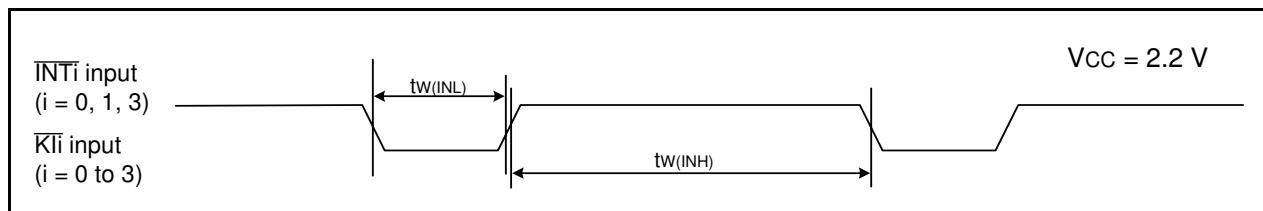
Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLK <i>i</i> input cycle time	800	—	ns
$t_{w(CKH)}$	CLK <i>i</i> input "H" width	400	—	ns
$t_{w(CKL)}$	CLK <i>i</i> input "L" width	400	—	ns
$t_{d(C-Q)}$	TXD <i>i</i> output delay time	—	200	ns
$t_{h(C-Q)}$	TXD <i>i</i> hold time	0	—	ns
$t_{su(D-C)}$	RXD <i>i</i> input setup time	150	—	ns
$t_{h(C-D)}$	RXD <i>i</i> input hold time	90	—	ns

 $i = 0, 2$ **Figure 5.14 Serial Interface Timing Diagram when $V_{CC} = 2.2\text{ V}$** **Table 5.30 External Interrupt $\overline{\text{INT}_i}$ ($i = 0, 1, 3$) Input, Key Input Interrupt $\overline{\text{K}_i}$ ($i = 0$ to 3)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(\text{INH})}$	$\overline{\text{INT}_i}$ input "H" width, $\overline{\text{K}_i}$ input "H" width	1000 ⁽¹⁾	—	ns
$t_{w(\text{INL})}$	$\overline{\text{INT}_i}$ input "L" width, $\overline{\text{K}_i}$ input "L" width	1000 ⁽²⁾	—	ns

Notes:

- When selecting the digital filter by the $\overline{\text{INT}_i}$ input filter select bit, use an $\overline{\text{INT}_i}$ input HIGH width of either (1/digital filter clock frequency \times 3) or the minimum value of standard, whichever is greater.
- When selecting the digital filter by the $\overline{\text{INT}_i}$ input filter select bit, use an $\overline{\text{INT}_i}$ input LOW width of either (1/digital filter clock frequency \times 3) or the minimum value of standard, whichever is greater.

**Figure 5.15 Input Timing for External Interrupt $\overline{\text{INT}_i}$ and Key Input Interrupt $\overline{\text{K}_i}$ when $V_{CC} = 2.2\text{ V}$**